

LDMOS RF Line Power FET Transistor 2 W, 800-2200 MHz, 28V

M/A-COM Products Preliminary - Rev. 12/07

Designed for broadband commercial applications up to 2.2GHz

- High gain, high efficiency and high linearity
- Ease of design for gain and insertion phase flatness
- Excellent thermal stability
- W-CDMA performance at 2.17GHz, 28Vdc

Average output power: 28dBm @ -39dBc ACPR

Gain: 14.5dB (typ.) Efficiency: 23% (typ.)

10:1 VSWR ruggedness at 2W (CW), 28V, 2.11GHz

Performance at 960MHz, 26Vdc, P_{1dB}
 Average output power: 2W min.

Gain: 20dB (typ.) Efficiency: 50% (typ.)

10:1 VSWR ruggedness at 2W, 26V, 960MHz

Product Image



MAXIMUM RATINGS

Parameter	Symbol	Rating	Units
Drain—Source Voltage	V_{DSS}	65	V _{dc}
Gate—Source Voltage	V_{GS}	+15, -0.5	V _{dc}
Total Power Dissipation @ T _c = 25 °C	Ръ	6.9	W
Storage Temperature	T _{STG}	-65 to +150	°C
Junction Temperature	ΤJ	150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{eJC}	18	°C/W

NOTE—**CAUTION**—MOS devices are susceptible to damage from electrostatic charge. Precautions in handling and packaging MOS devices should be observed.

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Characteristic	Symbol	Min	Тур	Max	Unit
DC CHARACTERISTICS @ 25°C	•				
Drain-Source Breakdown Voltage ($V_{GS} = 0 \text{ Vdc}$, $I_D = 30 \mu \text{Adc}$)	V _{(BR)DSS}	65	_	_	Vdc
Gate Threshold Voltage (V _{ds} = 26 Vdc, I _d = 25 mA)	$V_{GS(th)}$	2	_	5	Vdc
Gate Quiescent Voltage (V _{ds} = 26 Vdc, I _d = 25 mA)	$V_{GS(Q)}$	3	_	5	Vdc
Drain-Source On-Voltage (V _{gs} = 10 Vdc, I _d = 0.1 A)	$V_{DS(on)}$	_	0.30	_	Vdc
RF FUNCTIONAL TESTS @ 25°C (In M/A-COM Test Fixture)					
Common Source Amplifier Gain (V _{DD} = 28 Vdc, I _{DQ} = 35 mA, f = 2170 MHz, P _{OUT} = 2 W)	G _P	-	14	_	dB
Drain Efficiency (V _{DD} = 28 Vdc, I _{DQ} = 35 mA, f = 2170 MHz, P _{OUT} = 2 W)	EFF (ŋ)	_	38	_	%
Input Return Loss (V _{DD} = 28 Vdc, I _{DQ} = 35 mA, f = 2170 MHz, P _{OUT} = 2 W)	IRL	_	-9	_	dB
Output VSWR Tolerance (V _{DD} = 28 Vdc, I _{DQ} = 35 mA, f = 2170 MHz, P _{OUT} = 2 W, VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			
RF FUNCTIONAL TESTS @ 25°C (In M/A-COM Test Fixture show	vn in Figure 10))			
Common Source Amplifier Gain (V _{DD} = 26 Vdc, I _{DQ} = 35 mA, f = 1900 MHz, P _{OUT} = 2 W)	G _P	_	14.5	_	dB
Drain Efficiency (V _{DD} = 26 Vdc, I _{DQ} = 35 mA, f = 1900 MHz, P _{OUT} = 2 W)	EFF (ŋ)	_	40	_	%
Input Return Loss (V _{DD} = 26 Vdc, I _{DQ} = 35 mA, f = 1900 MHz, P _{OUT} = 2 W)	IRL	_	-10	_	dB
Output VSWR Tolerance (V _{DD} = 26 Vdc, I _{DQ} = 35 mA, f = 1900 MHz, P _{OUT} = 2 W, VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			

⁽¹⁾ Device specifications obtained on a Production Test Fixture.

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Characteristic	Symbol	Min	Тур	Max	Unit
RF FUNCTIONAL TESTS @ 25°C (In M/A-COM Test Fixture)					
Common Source Amplifier Gain (V _{DD} = 26 Vdc, I _{DQ} = 35 mA, f = 1670 MHz, P _{OUT} = 2 W)	G _P		15	-	dB
Drain Efficiency $(V_{DD} = 26 \text{ Vdc}, I_{DQ} = 35 \text{ mA}, f = 1670 \text{ MHz}, P_{OUT} = 2 \text{ W})$	EFF (ŋ)	_	45	_	%
Input Return Loss ($V_{DD} = 26 \text{ Vdc}$, $I_{DQ} = 35 \text{ mA}$, $f = 1670 \text{ MHz}$, $P_{OUT} = 2 \text{ W}$)	IRL		-11	_	dB
Output VSWR Tolerance (V_{DD} = 26 Vdc, I_{DQ} = 35 mA, f = 1670 MHz, P_{OUT} = 2 W, VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			

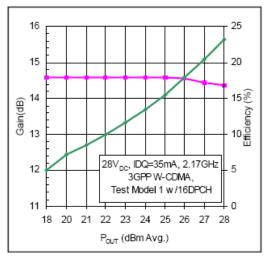
RF FUNCTIONAL TESTS @ 25°C (In M/A-COM Test Fixture shown in Figure 12)					
Common Source Amplifier Gain $(V_{DD} = 26 \text{ Vdc}, I_{DQ} = 50 \text{ mA}, f = 960 \text{ MHz}, P_{OUT} = 2 \text{ W})$	G _P	_	20	_	dB
Drain Efficiency (V _{DD} = 26 Vdc, I _{DQ} = 50 mA, f = 960 MHz, P _{OUT} = 2 W)	EFF (ŋ)	_	50	_	%
Input Return Loss (V_{DD} = 26 Vdc, I_{DQ} = 50 mA, f = 960 MHz, P_{OUT} = 2 W)	IRL	_	-12	_	dB
Output VSWR Tolerance (V _{DD} = 26 Vdc, I _{DQ} = 50 mA, f = 960 MHz, P _{OUT} = 2 W, VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			

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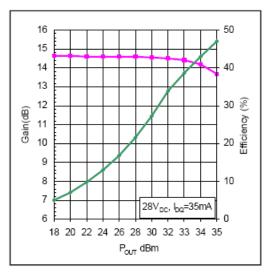
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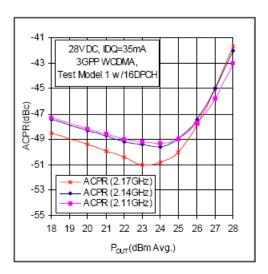
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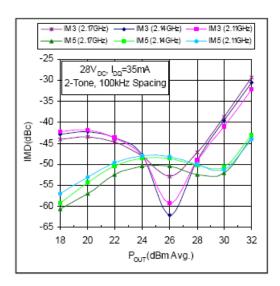
W-CDMA: Gain and Efficiency vs Output Power Graph 1.



CW: Gain and Efficiency vs Output Power Graph 3.



W-CDMA: ACPR vs Output Power. Graph 2.



Two Tone: Intermodulation Distortion vs Output Power Graph 4.

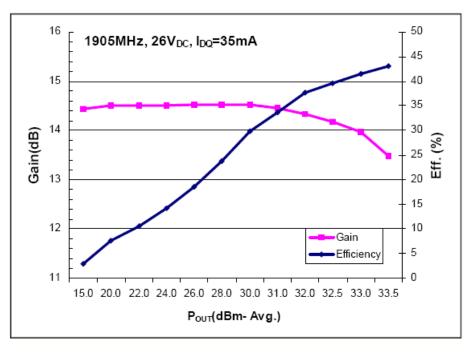
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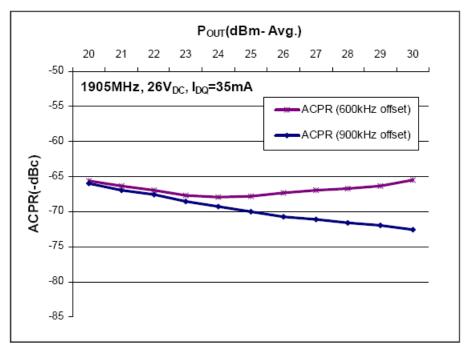


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GRAPH 5. PHS POWER GAIN AND DRAIN EFFICIENCY VS. OUTPUT POWER



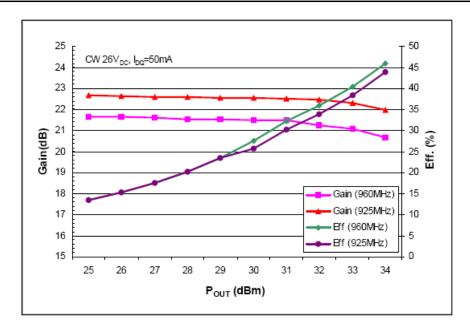
GRAPH 6. PHS ACPR VS. OUTPUT POWER

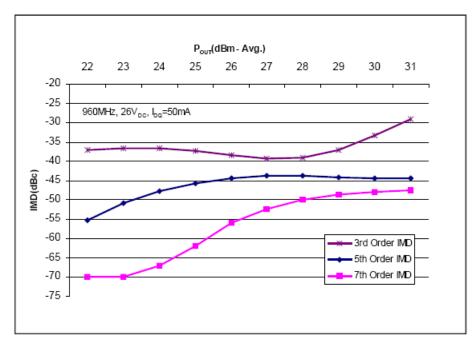
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GRAPH 8. INTERMODULATION DISTORTION VS. OUTPUT POWER

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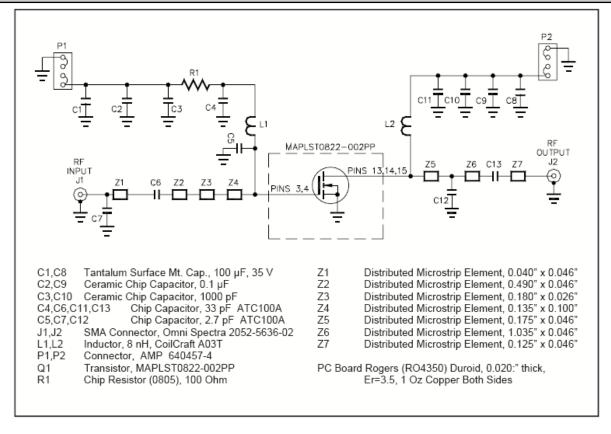


FIGURE 9. 1880—1920 MHZ TEST FIXTURE SCHEMATIC

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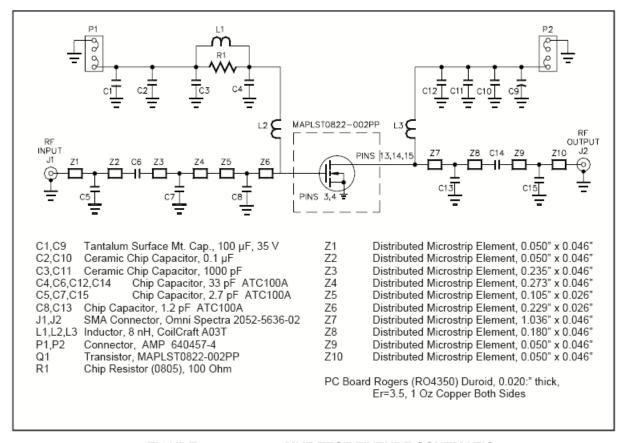


FIGURE 11. 920—960 MHZ TEST FIXTURE SCHEMATIC

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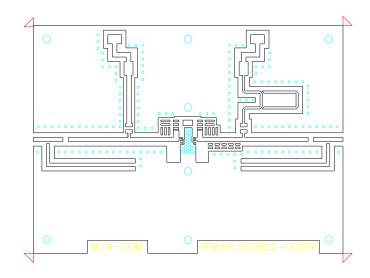
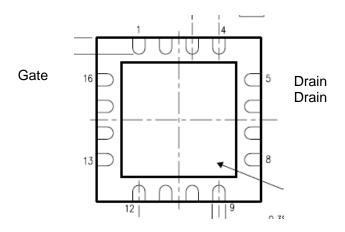


FIGURE 12. TEST FIXTURE PCB LAYOUT



Note: All other leads and bottom paddle are connected to the Source

FIGURE 13. 4 MM X 4 MM QFN PIN CONNECTIONS

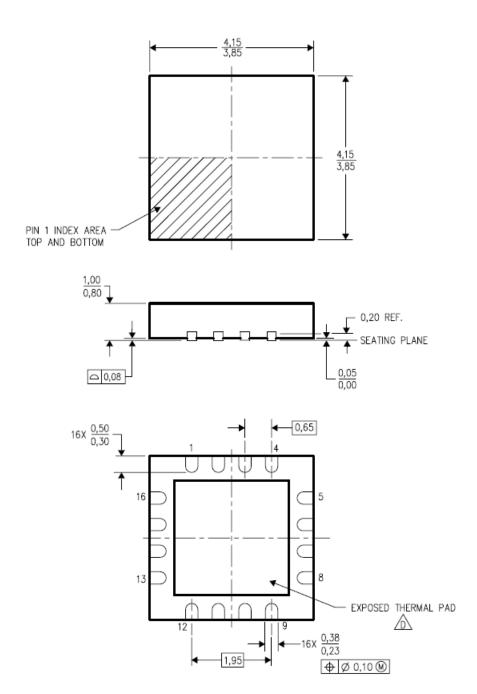
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PACKAGE DIMENSIONS



PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not guaranteed.

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